(2) The following table lists the compliance methods used on each affected tank process at this facility, noted previously in item (1) in Section 2:

Tank Process Description/ID No.	HAP Emitted or Used (Cd, Cr, Pb, Mn, Ni)	Compliance Method(s) (Check all that apply)
	(63, 6., ,	 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		Wetting agent/fume suppressant Vented to a control device; describe: Tank cover Time limit (short-term plating only) Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		Wetting agent/fume suppressant Vented to a control device; describe: Tank cover Time limit (short-term plating only) Management practices
		Wetting agent/fume suppressant Vented to a control device; describe: Tank cover Time limit (short-term plating only) Management practices
		Wetting agent/fume suppressant Vented to a control device; describe: Tank cover Time limit (short-term plating only) Management practices

Tank Process Description/ID No.	HAP Emitted or Used (Cd, Cr, Pb, Mn, Ni)	Compliance Method(s) (Check all that apply)
	(continued)	
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		Wetting agent/fume suppressant Vented to a control device; describe: Tank cover Time limit (short-term plating only) Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices
		 ☐ Wetting agent/fume suppressant ☐ Vented to a control device; ☐ describe: ☐ Tank cover ☐ Time limit (short-term plating only) ☐ Management practices

(3) The following table lists each affected thermal spraying booths/lines (temporary and permanent), and dry mechanical polishing processes subject to subpart WWWWWW, noted previously in item (1) in Section 2:

Thermal Spray Booth/Line or	HAP	Compliance Mathed(a)
Dry Mechanical Polishing	Emitted or Used	Compliance Method(s)
Description/ID No.	(Cd, Cr, Pb, Mn, Ni)	(Check all that apply)
2 3 3 3 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	(30, 31, 10, 1111, 111)	☐ Vented to a control device;
		describe:
		Management practices (temporary
		thermal spraying only)
		Vented to a control device;
		describe:
		Management practices (temporary
		thermal spraying only)
		Vented to a control device;
		describe:
		Management practices (temporary
		thermal spraying only)
		Vented to a control device;
		describe:
		thermal spraying only)
		Vented to a control device;
		describe:
		thermal spraying only)
		Vented to a control device;
		describe:
		Management practices (temporary
		_ , , , ,
		thermal spraying only)
		☐ Vented to a control device;
		describe:
		thermal spraying only)
		☐ Vented to a control device;
		describe:
		Management practices (temporary
		thermal spraying only)
		☐ Vented to a control device;
		describe:
		Management practices (temporary
		thermal spraying only)
		Vented to a control device;
		describe:
		thermal spraying only)
		Vented to a control device;
		describe:
		thermal spraying only)
	I	1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2

(5)	The following applicable management practices are used at this facility, as practicable:
	Minimize bath agitation when removing any parts processed in the tank, as practicable except when necessary to meet part quality requirements.
	Maximize the draining of bath solution back into the tank, as practicable, by extending drip time when removing parts from the tank; using drain boards (also known as drip shields); or withdrawing parts slowly from the tank, as practicable.
	Optimize the design of barrels, racks, and parts to minimize dragout of bath solution (such as by using slotted barrels and tilted racks, or by designing parts with flow-through holes to allow the tank solution to drip back into the tank), as practicable.
	Use tank covers, if already owned and available at the facility, whenever practicable.
	Minimize or reduce heating of process tanks, as practicable (e.g., when doing so would not interrupt production or adversely affect part quality).
	Perform regular repair, maintenance, and preventive maintenance of racks, barrels, and other equipment associated with affected sources, as practicable.
	Minimize bath contamination, such as through the prevention or quick recovery of dropped parts, use of distilled/de-ionized water, water filtration, pre-cleaning of parts to be plated, and thorough rinsing of pre-treated parts to be plated, as practicable.
	Maintain quality control of chemicals, and chemical and other bath ingredient concentrations in the tanks, as practicable.
	Perform general good housekeeping, such as regular sweeping or vacuuming, if needed, and periodic washdowns, as practicable.
	Minimize spills and overflow of tanks, as practicable.
	Use squeegee rolls in continuous or reel-to-reel plating tanks, as practicable.
	Perform regular inspections to identify leaks and other opportunities for pollution prevention.